AMP-HDI

TE Internal #: 532436-7

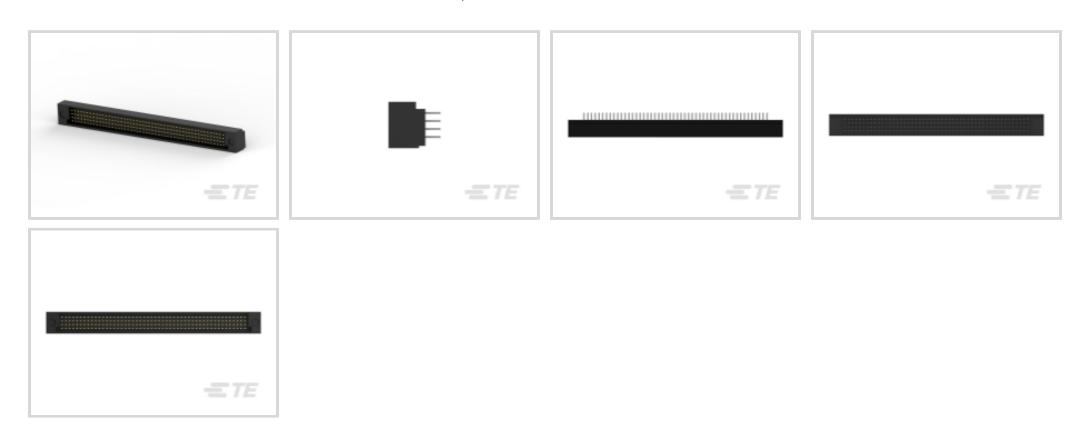
PCB Mount Header, Vertical, Board-to-Board, 200 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole -

Solder, Signal, Black

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 200
Number of Rows: 4

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	200
Number of Rows	4

 $4 M\Omega$

Electrical Characteristics

Insulation Resistance



Primary Product Color	Black
Contact Features	
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Four Beam
Contact Layout	Matrix
	.21 in
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Post & Tail Length	4.83 mm[.19 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Keyed
Mating Alignment Type PCB Mount Retention Type	Keyed Retention Solder Tails
PCB Mount Retention Type	Retention Solder Tails
PCB Mount Retention Type PCB Mount Retention	Retention Solder Tails Without
PCB Mount Retention Type PCB Mount Retention PCB Mount Alignment	Retention Solder Tails Without Without
PCB Mount Retention Type PCB Mount Retention PCB Mount Alignment Connector Mounting Type	Retention Solder Tails Without Without Board Mount
PCB Mount Retention Type PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment	Retention Solder Tails Without Without Board Mount
PCB Mount Retention PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features	Retention Solder Tails Without Without Board Mount Without
PCB Mount Retention PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features Housing Material	Retention Solder Tails Without Board Mount Without Thermoplastic
PCB Mount Retention PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features Housing Material Centerline (Pitch)	Retention Solder Tails Without Board Mount Without Thermoplastic
PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features Housing Material Centerline (Pitch) Dimensions	Retention Solder Tails Without Without Board Mount Without Thermoplastic 2.54 mm[.1 in]
PCB Mount Retention PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features Housing Material Centerline (Pitch) Dimensions PCB Thickness (Recommended)	Retention Solder Tails Without Without Board Mount Without Thermoplastic 2.54 mm[.1 in]
PCB Mount Retention Type PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features Housing Material Centerline (Pitch) Dimensions PCB Thickness (Recommended) Connector Height	Retention Solder Tails Without Without Board Mount Without Thermoplastic 2.54 mm[.1 in]



Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	4
Packaging Method	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) SVHC > Threshold: Pb (13% in 4690948374) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not lead free process capable

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts











Customers Also Bought



















TE Part #ZPF000000000207535 732-8254-22 T

Documents

Product Drawings

HDI PIN ASSY 4 ROW 200 POS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_532436-7_T.2d_dxf.zip

PCB Mount Header, Vertical, Board-to-Board, 200 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Solder, Signal, Black



English

Customer View Model

ENG_CVM_CVM_532436-7_T.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_532436-7_T.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

English

Agency Approvals

Agency Approval Document

English